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Team Nexperia



PMBTA42 300 V, 100 mA NPN high-voltage transistor Rev. 05 – 12 December 2008

Product data sheet

1. Product profile

1.1 General description

NPN high-voltage transistor in a small SOT23 (TO-236AB) Surface-Mounted Device (SMD) plastic package.

PNP complement: PMBTA92.

1.2 Features

High voltage (max. 300 V)

1.3 Applications

Telephony and professional communication equipment

1.4 Quick reference data

Table 1.	Quick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CEO}	collector-emitter voltage	open base	-	-	300	V
I _C	collector current		-	-	100	mA
h _{FE}	DC current gain	V _{CE} = 10 V				
		I _C = 1 mA	25	-	-	
		I _C = 10 mA	40	-	-	
		I _C = 30 mA	40	-	-	

2. Pinning information

Table 2.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
1	base		
2	emitter		3
3	collector		1
			sym021



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3. Ordering information

Table 3.OrderType number[1]	ing informati Package	on	
	Name	Description	Version
PMBTA42	-	plastic surface-mounted package; 3 leads	SOT23
PMBTA42/DG			
[1] /DG: halogen-fr	ee		

4. Marking

Table 4. Marking codes	
Type number ^[1]	Marking code ^[2]
PMBTA42	*1D
PMBTA42/DG	*BV

- [1] /DG: halogen-free
- [2] * = -: made in Hong Kong
 - * = p: made in Hong Kong
 - * = t: made in Malaysia
 - * = W: made in China

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CBO}	collector-base voltage	open emitter	-	300	V
V _{CEO}	collector-emitter voltage	open base	-	300	V
V _{EBO}	emitter-base voltage	open collector	-	6	V
I _C	collector current		-	100	mA
I _{CM}	peak collector current	single pulse; $t_p \leq 1 \text{ ms}$	-	200	mA
I _{BM}	peak base current	single pulse; $t_p \leq 1 \text{ ms}$	-	100	mA
P _{tot}	total power dissipation	$T_{amb} \leq 25 \ ^{\circ}C$	<u>[1]</u> -	250	mW
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C
T _{stg}	storage temperature		-65	+150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

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6. Thermal characteristics

Table 7.

Characteristics

Table 6.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	<u>[1]</u> -	-	500	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

7. Characteristics

$T_{amb} = 25$	$T_{amb} = 25 \ ^{\circ}C$ unless otherwise specified.						
Symbol	Parameter	Conditions	Min	Тур	Max	Unit	
I _{CBO}	collector-base cut-off current	$V_{CB} = 200 \text{ V}; I_E = 0 \text{ A}$	-	-	100	nA	
I _{EBO}	emitter-base cut-off current	$V_{EB} = 6 \text{ V}; I_{C} = 0 \text{ A}$	-	-	100	nA	
h _{FE}	DC current gain	V _{CE} = 10 V					
		$I_{\rm C} = 1 \rm{mA}$	25	-	-		
		I _C = 10 mA	40	-	-		
		I _C = 30 mA	40	-	-		
V _{CEsat}	collector-emitter saturation voltage	$I_{C} = 20 \text{ mA}; I_{B} = 2 \text{ mA}$	-	-	500	mV	
V _{BEsat}	base-emitter saturation voltage	$I_{C} = 20 \text{ mA}; I_{B} = 2 \text{ mA}$	-	-	900	mV	
C _{re}	feedback capacitance	$\label{eq:VCB} \begin{array}{l} V_{CB} = 20 \text{ V}; I_{C} = i_{c} = 0 \text{ A}; \\ f = 1 \text{ MHz} \end{array}$	-	-	3	pF	
f _T	transition frequency	V _{CE} = 20 V; I _C = 10 mA; f = 100 MHz	50	-	-	MHz	

300 V, 100 mA NPN high-voltage transistor

8. Package outline



Fig 1. Package outline SOT23 (TO-236AB)

300 V, 100 mA NPN high-voltage transistor

9. Packing information

Table 8. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing quantity		
			3000	10000	
PMBTA42	SOT23	4 mm pitch, 8 mm tape and reel	-215	-235	
PMBTA42/DG	_				

[1] For further information and the availability of packing methods, see <u>Section 13</u>.

[2] /DG: halogen-free

10. Soldering



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11. Revision history

Table 9. Revisio	n history			
Document ID	Release date	Data sheet status	Change notice	Supersedes
PMBTA42_5	20081212	Product data sheet	-	PMBTA42_4
Modifications:	 The format guidelines 	of this data sheet has been of NXP Semiconductors.	redesigned to comply w	vith the new identity
	 Legal texts 	have been adapted to the r	new company name whe	ere appropriate.
	 Type numb 	er PMBTA42/DG added		
	Table 4 "Ma	arking codes": enhanced		
	Section 12	"Legal information": update	d	
PMBTA42_4	20040122	Product specification	-	PMBTA42_3
PMBTA42_3	19990422	Product specification	-	PMBTA42_43_CNV_2

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12. Legal information

12.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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